

Standard specifications of $\Phi 2$ inch HVPE gallium oxide epitaxial wafers

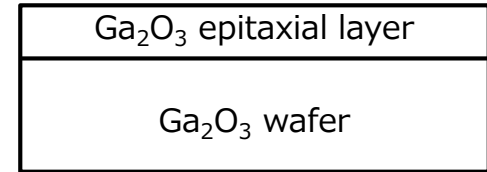
Epitaxial layer (Growth method: HVPE)

Property	Specification
Dopant	Si (n-type)
Doping concentration	Specify a value in the range between 2×10^{16} and $9 \times 10^{16} \text{ cm}^{-3}$
Thickness	Specify a value in the range between 5 and 10 μm

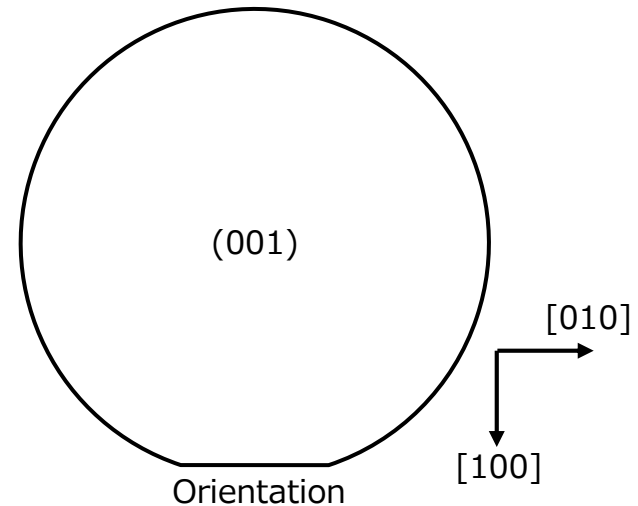
Property	Specification
Dopant	Sn (n-type)
Doping concentration	$1-9 \times 10^{18} \text{ cm}^{-3}$
Orientation	(001)
Size	$\Phi 2$ inch
Thickness	0.65 mm
XRD FWHM	≤ 350 arcsec
Off set angle	$0^\circ \pm 1^\circ$

Remarks

- 1 These products must be used for research and development purposes only.
- 2 The substrates must not be used as a seed crystal.
- 3 The specifications are subject to change without notice.



Cross section of Gallium oxide epitaxial wafers

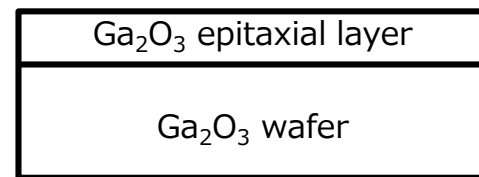


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Standard specifications of MBE gallium oxide epitaxial wafers

Epitaxial layer (Growth method: MBE)

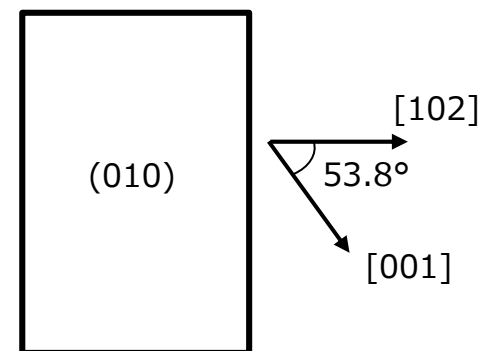
Property	Specification	
Dopant	Si (n-type)	Undoped (semi-insulating)
Doping concentration	Specify a value in the range between 5×10^{16} and $2 \times 10^{18} \text{ cm}^{-3}$	-
Thickness	Specify a value in the range between 0.1 and 0.5 μm	



Cross section of Gallium oxide epitaxial wafers

Wafers

Property	Specification	
Dopant	Sn (n-type)	Fe (semi-insulating)
Doping concentration	$1-9 \times 10^{18} \text{ cm}^{-3}$	-
Resistivity	-	$\geq 10^{10} \Omega\text{cm}$
Orientation	(010)	
Size	10x15 mm ²	
Thickness	0.5 mm	
XRD FWHM	$\leq 150 \text{ arcsec}$	
Off set angle	$0^\circ \pm 1^\circ$	



Orientation



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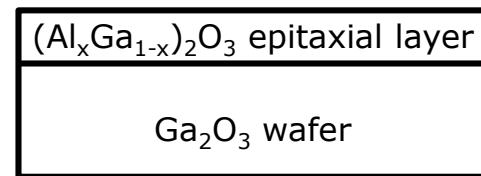
Remarks

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Standard specifications of MBE ($\text{Al}_x\text{Ga}_{1-x}$) $_2\text{O}_3$ epitaxial wafers

Epitaxial layer (Growth method: MBE)

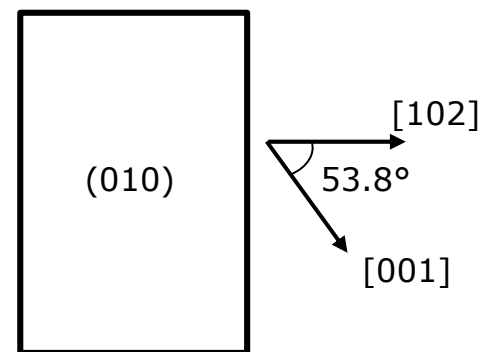
Property	Specification
Al mole fraction	$x \leq 0.23$
Dopant	Si (n-type)
Doping concentration	$\leq 1 \times 10^{18} \text{ cm}^{-3}$
Thickness	$\leq 60 \text{ nm}$



Cross section of Gallium oxide epitaxial wafer

Wafer

Property	Specification	
Dopant	Sn (n-type)	Fe (semi-insulating)
Doping concentration	$1-9 \times 10^{18} \text{ cm}^{-3}$	-
Resistivity	-	$\geq 10^{10} \Omega\text{cm}$
Orientation	(010)	
Size	10x15 mm	
Thickness	0.5 mm	
XRD FWHM	$\leq 150 \text{ arcsec}$	
Off set angle	$0^\circ \pm 1^\circ$	



Orientation



Novel Crystal Technology, Inc.

Remarks

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